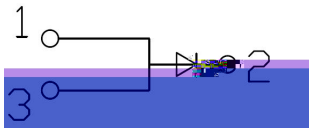
/ Descriptions

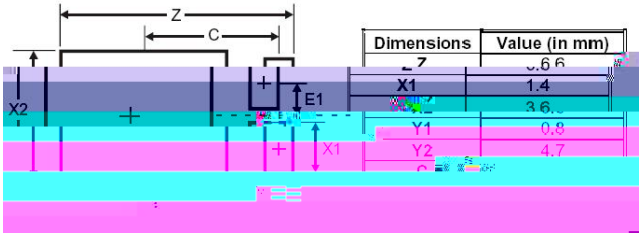
/ Features

/ Applications

/ Equivalent Circuit



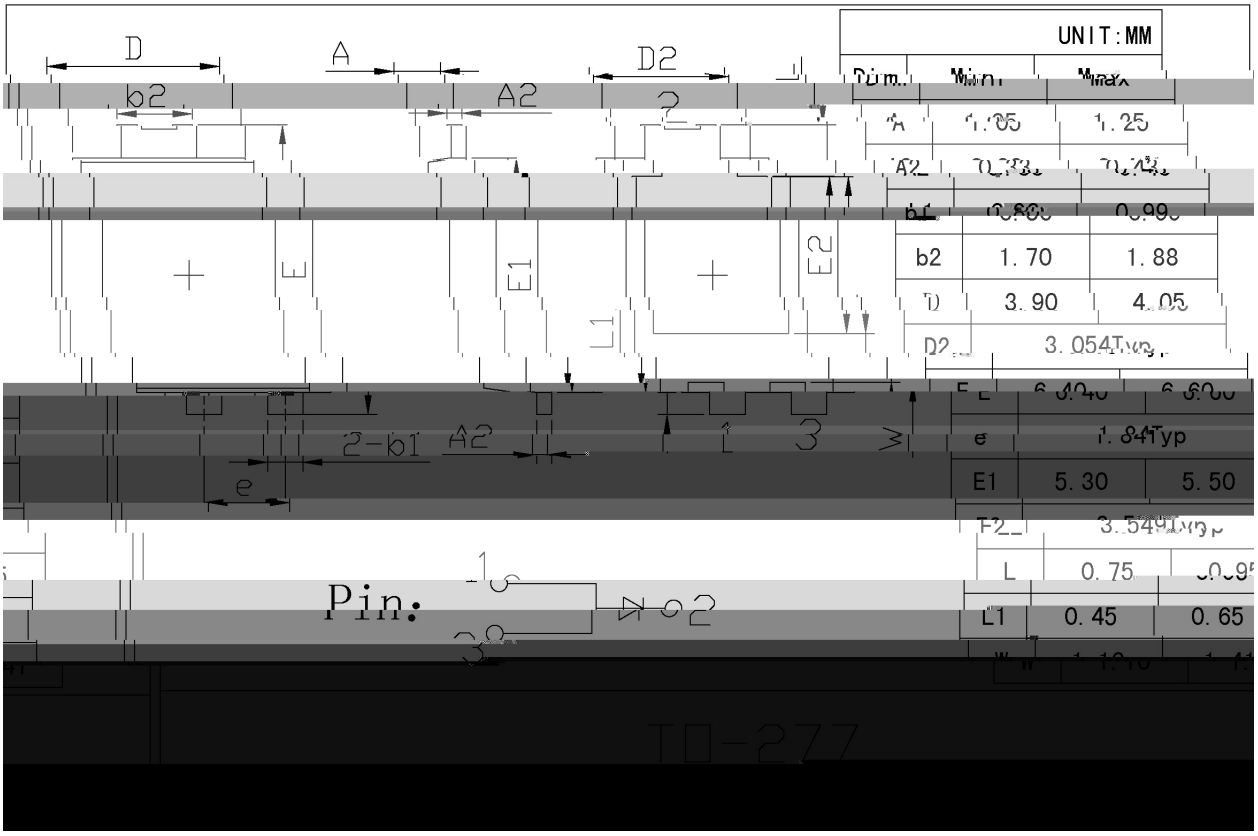
/ Pinning



/ h_{FE} Classifications & Marking

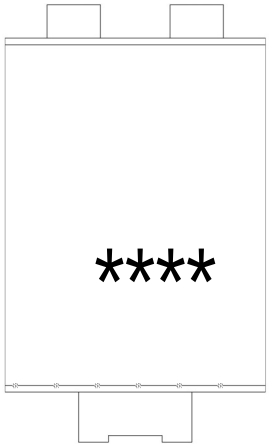
/ Electrical Characteristic Curve

/ Package Dimensions



Dim.	Min.	Max.
A	1.05	1.25
b2	1.70	1.88
D	3.90	4.05
D2	3.054Typ.	
e	1.84Typ	
E1	5.30	5.50
L	0.75	
L1	0.45	0.65

/ Marking Instructions



20S50

****

20S50

( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)

± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box
TO-277	5,000	3	15,000	6	90,000	13 ×12	360×360×50	380×335×366

/ Notices